

DESCRIPTION

ACTIVE MATRIX SUBSTRATE, LIQUID CRYSTAL DISPLAY DEVICE, AND
METHOD FOR MANUFACTURING ACTIVE MATRIX SUBSTRATE

TECHNICAL FIELD

[0001] The present invention relates to an active matrix substrate, and more particularly to an active matrix substrate having two-layered electrodes, including an upper layer electrode and a lower layer electrode. Moreover, the present invention relates to a liquid crystal display device having such an active matrix substrate, and a method of producing such an active matrix substrate.

BACKGROUND ART

[0002] Liquid crystal display devices, due to their thinness and low power consumption, are broadly used in various fields. In particular, active-matrix type liquid crystal display devices have high performance with a high contrast ratio and excellent response characteristics, and

are used for television sets, monitors, and laptop personal computers; they are increasing in market size in the recent years.

[0003] Generally speaking, an active-matrix type liquid crystal display device includes an active matrix substrate (also referred to as a "TFT substrate") on which thin film transistors (TFTs) are formed as switching elements corresponding to the respective pixels, a counter substrate (also referred to as a "color filter substrate") on which color filters and the like are formed, and a liquid crystal layer provided between the active matrix substrate and the counter substrate. An electric field which is in accordance with the potential difference between the common electrode and a pixel electrode electrically connected to a thin film transistor is applied across the liquid crystal layer, this electric field causing a change in the alignment state of liquid crystal molecules in the liquid crystal layer, thereby controlling the light transmittance of each pixel to enable displaying.

[0004] Depending on the application, various display modes

have been proposed and adopted in active-matrix type liquid crystal display devices. Examples of display modes include the TN (Twisted Nematic) mode, the VA (Vertical Alignment) mode, the IPS (In-Plane-Switching) mode, and the FFS (Fringe Field Switching) mode.

[0005] In some display modes, a "two-layer electrode structure" is adopted for the active matrix substrate. A two-layer electrode structure includes the following, on an interlayer insulating layer covering thin film transistors: a lower layer electrode(s), a dielectric layer covering the lower layer electrode(s), and an upper layer electrode(s) overlying the lower layer electrode(s) via the dielectric layer. For example, in the commonly-used FFS mode, as is disclosed in Patent Document 1, a common electrode is provided as a lower layer electrode, and pixel electrodes having a plurality of slits formed therein are provided as upper layer electrodes. Both the common electrode and the pixel electrodes are made of a transparent electrically conductive material. As is disclosed in Patent Document 2, a construction is also known for the FFS mode where pixel

electrodes are provided as lower layer electrodes, and a common electrode having a plurality of slits formed therein is provided as an upper layer electrode.

[0006] For reasons that will be described in detail later, a two-layer electrode structure may possibly be adopted irrespective of the display mode (that is, also in the VA mode and the like).

[0007] When adopting a two-layer electrode structure featuring pixel electrodes as upper layer electrodes, in order to electrically connect a pixel electrode to the drain electrode of a thin film transistor, an aperture through which to expose a portion of the drain electrode must be formed in both the interlayer insulating layer covering the thin film transistor and the dielectric layer located between the electrodes. By forming the pixel electrode so as to be in contact with the drain electrode in a contact hole which includes an aperture through the interlayer insulating layer and an aperture through the dielectric layer, the pixel electrode is allowed to be electrically connected to the drain electrode.

[0008] In this case, the etching to form the aperture in the dielectric layer will also erode the tapered portion (slanted side face) of the aperture in the interlayer insulating layer, thus allowing the side face shape of the contact hole to become steep. As a result, the pixel electrode, having a relatively small thickness, may become disrupted in the contact hole (called "stepping"). Therefore, in order to avoid insufficient connection due to stepping of the pixel electrode, the aperture in the dielectric layer is formed so that it wholly fits within the aperture in the interlayer insulating layer when viewed from the normal direction of the substrate.

CITATION LIST

PATENT LITERATURE

[0009] [Patent Document 1] Japanese Laid-Open Patent Publication No. 2002-182230

[Patent Document 2] Japanese Laid-Open Patent Publication No. 2011-53443

SUMMARY OF INVENTION

TECHNICAL PROBLEM

[0010] However, since the dielectric layer has a large film thickness to be etched, the aperture in the dielectric layer is likely to have a large finished diameter along the plane of the substrate. Therefore, the aperture in the interlayer insulating layer, within which the aperture in the dielectric layer is contained, inevitably needs to have a large diameter, too.

[0011] On the other hand, the drain electrode serves not only to provide electrical connection to the pixel electrode, but also to shade regions in which the liquid crystal molecules have disorderly alignment, near the tapered portion of the aperture in the interlayer insulating layer. Therefore, when the aperture in the interlayer insulating layer increases in diameter, the drain electrode size must also be increased.

[0012] The drain electrodes are typically in the same layer as the signal lines (that is, they are formed by patterning the same electrically conductive film).

Therefore, when a liquid crystal display device having high definition is given a standard pixel construction in which the ratio between the pixel pitch along the horizontal direction and the pixel pitch along the vertical direction (H/V ratio) is 1:3, it is impossible to ensure sufficient intralayer spaces along the horizontal direction if a large drain electrode size exists for the aforementioned reason. This will impose constraints as to definition, thus making manufacture difficult at high definitions. Specifically, manufacture at pixel densities of 370 ppi or more will become difficult.

[0013] The present invention has been made in view of the above problems, and an objective thereof is to provide an active matrix substrate which can be produced with a higher definition than conventionally, in spite of having a two-layer electrode structure.

SOLUTION TO PROBLEM

[0014] An active matrix substrate according to an embodiment of the present invention comprises: a substrate; a

thin film transistor being supported by the substrate and including a semiconductor layer, a gate electrode, a source electrode, and a drain electrode; a scanning line provided so as to extend substantially parallel to a first direction, and electrically connected to the gate electrode of the thin film transistor; a signal line provided so as to extend substantially parallel to a second direction orthogonal to the first direction, and electrically connected to the source electrode of the thin film transistor; a first interlayer insulating layer provided so as to cover the thin film transistor; a lower layer electrode provided on the first interlayer insulating layer; a dielectric layer provided on the lower layer electrode; and an upper layer electrode being provided on the dielectric layer and overlapping at least a portion of the lower layer electrode via the dielectric layer, wherein, a first contact hole through which a portion of the drain electrode is exposed is formed in the first interlayer insulating layer and the dielectric layer, the first contact hole allowing the upper layer electrode to be electrically connected to the drain electrode; the first

contact hole includes a first aperture formed in the first interlayer insulating layer and a second aperture formed in the dielectric layer; a width of the first aperture along one of the first direction and the second direction is smaller than a width of the second aperture along the one direction; when viewed from a normal direction of the substrate, a portion of the contour of the second aperture is located inside the contour of the first aperture, and the contour of the second aperture is not rectangular; and the area of a portion of the second aperture not overlapping the first aperture is smaller than that in an imaginary case where the contour of the second aperture is a rectangle whose width along the first direction and whose width along the second direction are identical to those of the contour of the second aperture.

[0015] In one embodiment, when viewed from the normal direction of the substrate, the contour of the first aperture is rectangular.

[0016] In one embodiment, when viewed from the normal direction of the substrate, the second aperture includes a

first portion overlapping the first aperture, and a plurality of second portions extending from the first portion and not overlapping the first aperture; and the plurality of second portions include at least one second portion located on one side of the first portion along the one direction and at least another second portion located on another side.

[0017] In one embodiment, the plurality of second portions are four second portions; and two of the four second portions are located on one side of the first portion along the one direction, and the other two are located on another side.

[0018] In one embodiment, when viewed from the normal direction of the substrate, the contour of the second aperture is H-shaped.

[0019] In one embodiment, wherein, the plurality of second portions are two second portions; and one of the two second portions is located on one side of the first portion along the one direction, and the other is located on another side.

[0020] In one embodiment, when viewed from the normal direction of the substrate, the contour of the second aperture is a parallelogram.

[0021] In one embodiment, when viewed from the normal direction of the substrate, the contour of the second aperture includes two sides which are substantially parallel to the one direction, each being located partially inside the contour of the first aperture.

[0022] In one embodiment, when viewed from the normal direction of the substrate, the contour of the second aperture includes two sides which are inclined with respect to the one direction, each being located partially inside the contour of the first aperture.

[0023] In one embodiment, a width of the first aperture along the other of the first direction and the second direction is greater than a width of the second aperture along the other direction.

[0024] In one embodiment, in the first contact hole, the upper layer electrode is in contact with the drain electrode.

[0025] In one embodiment, the active matrix substrate of the above construction further comprises: a gate insulating layer provided between the semiconductor layer and the gate electrode; and a second interlayer insulating layer provided

so as to cover the gate electrode or the semiconductor layer, wherein, between the gate insulating layer and the second interlayer insulating layer, at least the second interlayer insulating layer has a second contact hole formed therein through which a portion of the semiconductor layer is exposed, the second contact hole allowing the drain electrode to be electrically connected to the semiconductor layer; and when viewed from the normal direction of the substrate, at least a portion of the second contact hole overlaps the first contact hole.

[0026] In one embodiment, when viewed from the normal direction of the substrate, a center of the first contact hole and a center of the second contact hole are deviated.

[0027] In one embodiment, the upper layer electrode and the lower layer electrode are each made of a transparent electrically conductive material.

[0028] In one embodiment, a width of the first aperture along the first direction is smaller than a width of the second aperture along the first direction.

[0029] In one embodiment, the semiconductor layer of the

thin film transistor comprises an oxide semiconductor.

[0030] In one embodiment, the oxide semiconductor is an In-Ga-Zn-O-type semiconductor.

[0031] A liquid crystal display device according to an embodiment of the present invention comprises: the active matrix substrate of the above construction; a counter substrate provided opposite from the active matrix substrate; and a liquid crystal layer provided between the active matrix substrate and the counter substrate.

[0032] In one embodiment, the liquid crystal display device of the above construction has a plurality of pixels in a matrix arrangement, wherein the upper layer electrode functions as a pixel electrode.

[0033] In one embodiment, the upper layer electrode has a plurality of slits.

[0034] In one embodiment, the lower layer electrode, the dielectric layer, and the upper layer electrode constitute a storage capacitor.

[0035] A method for producing an active matrix substrate according to an embodiment of the present invention is a

method of producing an active matrix substrate including: a thin film transistor including a semiconductor layer, a gate electrode, a source electrode, and a drain electrode; a scanning line provided so as to extend substantially parallel to a first direction, and electrically connected to the gate electrode of the thin film transistor; and a signal line provided so as to extend substantially parallel to a second direction orthogonal to the first direction, and electrically connected to the source electrode of the thin film transistor, the method comprising: step (A) of forming the thin film transistor on a substrate; step (B) of forming an interlayer insulating layer covering the thin film transistor, the interlayer insulating layer having a first aperture; step (C) of forming a lower layer electrode on the interlayer insulating layer; step (D) of forming on the lower layer electrode a dielectric layer having a second aperture; and step (E) of forming on the dielectric layer an upper layer electrode overlapping at least a portion of the lower layer electrode via the dielectric layer, the upper layer electrode being electrically connected to the drain electrode

in a contact hole, the contact hole including the first aperture and the second aperture, wherein, step (B) and step (D) are performed so that a width of the first aperture along one of the first direction and the second direction is smaller than a width of the second aperture along the one direction, and that, when viewed from a normal direction of the substrate, a portion of the contour of the second aperture is located inside the contour of the first aperture; and step (B) and step (D) are performed further so that, when viewed from the normal direction of the substrate, the contour of the second aperture is not rectangular, and that the area of a portion of the second aperture not overlapping the first aperture is smaller than that in an imaginary case where the contour of the second aperture is a rectangle whose width along the first direction and whose width along the second direction are identical to those of the contour of the second aperture.

ADVANTAGEOUS EFFECTS OF INVENTION

[0036] According to an embodiment of the present

invention, there is provided an active matrix substrate which can be produced with a higher definition than conventionally, in spite of having a two-layer electrode structure.

BRIEF DESCRIPTION OF DRAWINGS

[0037] [FIG. 1] A diagram schematically showing an active matrix substrate **100A** according to an embodiment of the present invention, as a plan view showing a region corresponding to one pixel.

[FIG. 2] A diagram schematically showing the active matrix substrate **100A** according to an embodiment of the present invention, where **(a)**, **(b)**, and **(c)** are cross-sectional views taken along line **2A-2A'**, line **2B-2B'**, and line **2C-2C'** in FIG. 1, respectively.

[FIG. 3] **(a)** and **(b)** are diagrams showing enlarged the neighborhood of a first aperture **16a** and a second aperture **18a** in the active matrix substrate **100A** according to an embodiment of the present invention.

[FIG. 4] A diagram schematically showing an active matrix substrate **1000** according to Comparative Example 1, as

a plan view showing a region corresponding to one pixel.

[FIG. 5] A diagram schematically showing the active matrix substrate **1000** according to Comparative Example 1, as a cross-sectional view taken along line **5A-5A'** in FIG. 4.

[FIG. 6] A diagram schematically showing an active matrix substrate **1100** according to Comparative Example 2, as a plan view showing a region corresponding to one pixel.

[FIG. 7] A diagram schematically showing the active matrix substrate **1100** according to Comparative Example 2, where **(a)** and **(b)** are cross-sectional views taken along line **7A-7A'** and line **7B-7B'** in FIG. 6, respectively.

[FIG. 8] A diagram showing regions **R1** where leakage of light may occur in the active matrix substrate **1100** according to Comparative Example 2.

[FIG. 9] **(a)** is a diagram showing a second aperture **18a** only having a first portion **18a1**; **(b)** is a diagram showing the second aperture **18a** shown in **(a)** being deviated from the intended position due to misalignment; and **(c)** is a diagram (a cross-sectional view taken along line **9C-9C'** in **(b)**) showing a cross-sectional structure of a region **R2** in which

the second aperture **18a** no longer overlaps the first aperture **16a** due to such deviation.

[FIG. 10] **(a)** and **(b)** are diagrams showing the second aperture **18a** in the active matrix substrate **100A** according to an embodiment of the present invention being deviated from the intended position due to misalignment.

[FIG. 11] Step-by-step cross-sectional views showing a method of producing the active matrix substrate **100A** according to an embodiment of the present invention, where **(a1)** to **(a3)** correspond to a cross section taken along line **2A-2A'** in FIG. 1; **(b1)** to **(b3)** correspond to a cross section taken along line **2B-2B'** in FIG. 1; and **(c1)** to **(c3)** correspond to a cross section taken along line **2C-2C'** in FIG. 1.

[FIG. 12] Step-by-step cross-sectional views showing a method of producing the active matrix substrate **100A** according to an embodiment of the present invention, where **(a1)** and **(a2)** correspond to a cross section taken along line **2A-2A'** in FIG. 1; **(b1)** and **(b2)** correspond to a cross section taken along line **2B-2B'** in FIG. 1; and **(c1)** and **(c2)**

correspond to a cross section taken along line **2C-2C'** in FIG. 1.

[FIG. 13] Step-by-step cross-sectional views showing a method of producing the active matrix substrate **100A** according to an embodiment of the present invention, where **(a1)** and **(a2)** correspond to a cross section taken along line **2A-2A'** in FIG. 1; **(b1)** and **(b2)** correspond to a cross section taken along line **2B-2B'** in FIG. 1; and **(c1)** and **(c2)** correspond to a cross section taken along line **2C-2C'** in FIG. 1.

[FIG. 14] Step-by-step cross-sectional views showing a method of producing the active matrix substrate **100A** according to an embodiment of the present invention, where **(a1)** and **(a2)** correspond to a cross section taken along line **2A-2A'** in FIG. 1; **(b1)** and **(b2)** correspond to a cross section taken along line **2B-2B'** in FIG. 1; and **(c1)** and **(c2)** correspond to a cross section taken along line **2C-2C'** in FIG. 1.

[FIG. 15] A diagram schematically showing an active matrix substrate **100B** according to an embodiment of the

present invention, as a plan view showing a region corresponding to one pixel.

[FIG. 16] A diagram schematically showing the active matrix substrate **100B** according to an embodiment of the present invention, where **(a)**, **(b)**, and **(c)** are cross-sectional views taken along line **16A-16A'**, line **16B-16B'**, and line **16C-16C'** in FIG. 15, respectively.

[FIG. 17] **(a)** and **(b)** are diagrams showing enlarged the neighborhood of a first aperture **16a** and a second aperture **18a** in the active matrix substrate **100B** according to an embodiment of the present invention.

[FIG. 18] A diagram showing in the active matrix substrate **100B** according to an embodiment of the present invention, the second aperture **18a** and a drain electrode **24** being deviated from their intended relative positioning due to misalignment.

[FIG. 19] A diagram schematically showing an active matrix substrate **100C** according to an embodiment of the present invention, as a plan view showing a region corresponding to one pixel.

[FIG. 20] A diagram schematically showing the active matrix substrate **100C** according to an embodiment of the present invention, where **(a)**, **(b)**, and **(c)** are cross-sectional views taken along line **20A-20A'**, line **20B-20B'**, and line **20C-20C'** in FIG. 19, respectively.

[FIG. 21] **(a)** and **(b)** are diagrams showing enlarged the neighborhood of a first aperture **16a** and a second aperture **18a** in the active matrix substrate **100C** according to an embodiment of the present invention.

[FIG. 22] A diagram showing the second aperture **18a** and a drain electrode **24** being deviated from their intended relative positioning due to misalignment in the active matrix substrate **100C** according to an embodiment of the present invention.

[FIG. 23] A diagram schematically showing an active matrix substrate **100D** according to an embodiment of the present invention, as a plan view showing a region corresponding to one pixel.

[FIG. 24] A diagram schematically showing the active matrix substrate **100D** according to an embodiment of the

present invention, where **(a)** and **(b)** are cross-sectional views taken along line **24A-24A'** and line **24B-24B'** in FIG. 23, respectively.

[FIG. 25] **(a)** and **(b)** are diagrams showing enlarged the neighborhood of a first aperture **16a** and a second aperture **18a** in the active matrix substrate **100D** according to an embodiment of the present invention.

[FIG. 26] A diagram showing the second aperture **18a** and a drain electrode **24** being deviated from their intended relative positioning due to misalignment in the active matrix substrate **100D** according to an embodiment of the present invention.

[FIG. 27] A diagram schematically showing an active matrix substrate **100E** according to an embodiment of the present invention, as a plan view showing a region corresponding to one pixel.

[FIG. 28] A diagram schematically showing the active matrix substrate **100E** according to an embodiment of the present invention, where **(a)**, **(b)**, and **(c)** are cross-sectional views taken along line **28A-28A'**, line **28B-28B'**, and

line **28C-28C'** in FIG. **27**, respectively.

[FIG. **29**] A cross-sectional view schematically showing a liquid crystal display device **200** in which the active matrix substrates **100A** to **100D** according to preferred embodiments of the present invention may be used.

[FIG. **30**] A diagram showing an example pixel structure when adopting the VA mode for the liquid crystal display device **200**, as a plan view showing a region corresponding to one pixel.

[FIG. **31**] A diagram showing another example pixel structure when adopting the VA mode for the liquid crystal display device **200**, as a plan view showing a region corresponding to one pixel.

[FIG. **32**] A diagram showing still another example pixel structure when adopting the VA mode for the liquid crystal display device **200**, as a plan view showing a region corresponding to one pixel.

[FIG. **33**] A diagram showing still another example pixel structure when adopting the VA mode for the liquid crystal display device **200**, as a plan view showing a region

corresponding to one pixel.

[FIG. 34] A diagram showing an example pixel structure when adopting the FFS mode for the liquid crystal display device **200**, as a plan view showing a region corresponding to one pixel.

[FIG. 35] A diagram showing another example pixel structure when adopting the FFS mode for the liquid crystal display device **200**, as a plan view showing a region corresponding to one pixel.

DESCRIPTION OF EMBODIMENTS

[0038] Hereinafter, embodiments of the present invention will be described with reference to the drawings. Note that the present invention is not limited to the following embodiments.

[0039] (Embodiment 1)

FIG. 1 and FIG. 2 show an active matrix substrate **100A** according to the present embodiment. FIG. 1 is a plan view schematically showing the active matrix substrate **100A**. FIGS. 2(a), (b), and (c) are cross-sectional views taken

along line **2A-2A'**, line **2B-2B'**, and **2C-2C'** in FIG. 1, respectively.

[0040] The active matrix substrate **100A** is used for a liquid crystal display device which performs displaying in the VA mode. The liquid crystal display device includes a plurality of pixels in a matrix arrangement. FIG. 1 shows a region corresponding to one pixel of the liquid crystal display device.

[0041] As shown in FIG. 1 and FIGS. 2(a) to (b), the active matrix substrate **100A** includes a substrate **10**, thin film transistors (TFTs) **20**, scanning lines **11**, and signal lines **12**.

[0042] The substrate **10** is transparent and insulative. The substrate **10** is typically a glass substrate.

[0043] The TFTs **20** are supported on the substrate **10**. Each TFT **20** includes a semiconductor layer **21**, gate electrodes **22**, a source electrode **23**, and a drain electrode **24**. In the present embodiment, the TFTs **20** are top-gate type TFTs. Moreover, each TFT **20** has a so-called double gate structure, including two gates (i.e., two gate electrodes **22**

are provided).

[0044] The scanning lines (also referred to as "gate bus lines") **11** are provided so as to extend substantially parallel to a certain direction (first direction). In the present embodiment, the first direction is the horizontal direction on the display surface of the liquid crystal display device. The scanning lines **11** are electrically connected to the gate electrodes **22** of the TFT **20**.

[0045] The signal lines (also referred to as "source bus lines") **12** are provided so as to extend substantially parallel to a direction (second direction) which is orthogonal to the first direction. In the present embodiment, the second direction is the vertical direction of the display surface of the liquid crystal display device. The signal lines **12** are electrically connected to the source electrodes of the TFTs **20**.

[0046] A basecoat layer **13** is formed on the surface of the substrate **10**, such that the semiconductor layer **21** of the TFTs **20** is provided upon the basecoat layer **13**. As the material of the semiconductor layer **21**, various known

semiconductor materials can be used; for example, amorphous silicon, polycrystalline silicon, continuous grain silicon (CGS), or the like can be used. Alternatively, an oxide semiconductor such as an In-Ga-Zn-O type semiconductor may also be used.

[0047] A gate insulating layer **14** is formed so as to cover the semiconductor layer **21**, such that the scanning lines **11** and the gate electrodes **22** are provided upon the gate insulating layer **14**. In other words, the gate insulating layer **14** is provided between the semiconductor layer **21** and the gate electrodes **22**. In the present embodiment, the portions of the scanning lines **11** that overlap the semiconductor layer **21** function as the gate electrodes **22**.

[0048] An interlayer insulating layer **15** is provided so as to cover the scanning lines **11** and the gate electrodes **22**, such that the signal lines **12**, the source electrodes **23**, and the drain electrodes **24** are provided upon the interlayer insulating layer **15**. In the gate insulating layer **14** and the interlayer insulating layer **15**, contact holes **32** and **33** through which portions of the semiconductor layer **21** are

exposed are formed. The former contact holes **32** allow the drain electrodes **24** to be electrically connected to the semiconductor layer **21**. In the present embodiment, a drain electrode **24** achieves contact with the semiconductor layer **21** in each contact hole **32**, whereby the semiconductor layer **21** and the drain electrode **24** are electrically connected to each other. The latter contact holes **33** allow the source electrodes **23** to be electrically connected to the semiconductor layer **21**. In the present embodiment, a source electrode **23** achieves contact with the semiconductor layer **21** in each contact hole **33**, whereby the semiconductor layer **21** and the source electrode **23** are electrically connected to each other.

[0049] As shown in FIG. **1** and FIGS. **2(a)** to **(c)**, the active matrix substrate **100A** further includes an interlayer insulating layer **16**, a lower layer electrode **17**, a dielectric layer **18**, and upper layer electrodes **19**.

[0050] The interlayer insulating layer **16** is provided so as to cover the TFTs **20**. More specifically, the interlayer insulating layer **16** is formed on the signal lines **12**, the

source electrodes **23**, the drain electrodes **24**, and the like. Hereinafter, the interlayer insulating layer **16**, which takes a relatively upper position, is referred to as the "first interlayer insulating layer", whereas the interlayer insulating layer **15**, which takes a relatively lower position, is referred to as the "second interlayer insulating layer".

[0051] The lower layer electrode **17** is provided on the first interlayer insulating layer **16**. The lower layer electrode **17** is formed continuously over all pixels. However, the lower layer electrode **17** is not formed near contact holes **31**, which will be described later.

[0052] The dielectric layer **18** is provided on the lower layer electrode **17**.

[0053] The upper layer electrodes **19** are provided on the dielectric layer **18**. The upper layer electrodes **19** overlap at least portions of the lower layer electrode **17** via the dielectric layer **18**. The upper layer electrodes **19** are formed independently (in isolated forms) for the respective pixels. In the present embodiment, an upper layer electrode **19** accounts for substantially the entirety of each pixel,

thus constituting a so-called spread electrode in which no slits or apertures are formed. Moreover, the upper layer electrodes **19** are electrically connected to the drain electrodes **24** of the TFTs **20**, so that display signal voltages are supplied thereto from the signal lines **11**, via the TFTs **20**. In other words, the upper layer electrodes **19** function as the pixel electrodes.

[0054] On the other hand, the lower layer electrode **17** has a storage capacitor voltage (Cs voltage) supplied thereto, thus functioning as a storage capacitor line and a storage capacitor electrode. In other words, the lower layer electrode **17** and upper layer electrodes **19**, and the dielectric layer **18** interposed therebetween, constitute a storage capacitor. The upper layer electrodes **19** functioning as the pixel electrodes and the lower layer electrode **17** functioning as the storage capacitor electrode are each made of a transparent electrically conductive material (e.g., ITO).

[0055] In the first interlayer insulating layer **16** and the dielectric layer **18**, contact holes **31** are formed, through

which portions of the drain electrodes **24** are exposed. The contact holes **31** allow the upper layer electrodes **19** to be electrically connected to the drain electrodes **24**. In the present embodiment, the upper layer electrodes **19** achieve contact with the drain electrode **24** in the contact hole **31**, whereby the drain electrodes **24** and the upper layer electrodes **19** are electrically connected to one another.

[0056] Hereinafter, the contact hole **31** for allowing the upper layer electrodes **19** to be electrically connected to the drain electrodes **24** will be referred to as the "first contact holes". On the other hand, the contact hole **32** for allowing the drain electrodes **24** to be electrically connected to the semiconductor layer **21** will be referred to as "second contact holes", whereas the contact holes **33** for allowing the source electrodes **23** to be electrically connected to the semiconductor layer **21** will be referred to as "third contact holes".

[0057] Each first contact hole **31** includes a first aperture **16a** formed in the first interlayer insulating layer **16** and a second aperture **18a** formed in the dielectric layer

18. As shown in FIG. 1, a width $W1_H$ of the first aperture 16a along the horizontal direction (first direction) is smaller than a width $W2_H$ of the second aperture 18a along the horizontal direction. Moreover, a width $W1_V$ of the first aperture 16a along the vertical direction (second direction) is greater than a width $W2_V$ of the second aperture 18a along the vertical direction.

[0058] Furthermore, when viewed from the normal direction of the substrate 10, portions of the contour of the second aperture 18a are located inside the contour of the first aperture 16a. More specifically, the contour of the second aperture 18a includes two sides (an upper side and a lower side) which are substantially parallel to the horizontal direction, each being located partially inside the contour of the first aperture 16a. Thus, the contour of the second aperture 18a and the contour of the first aperture 16a intersect each other.

[0059] Now, with reference to FIGS. 3(a) and (b), the shapes and positioning of the first aperture 16a and the second aperture 18a will be described in more detail. FIGS.

3(a) and **(b)** are diagrams showing enlarged the neighborhood of the first aperture **16a** and the second aperture **18a**. In FIG. **3(a)**, the contour of the first aperture **16a** is shown with a solid line, whereas the contour of the second aperture **18a** is shown with a broken line. On the other hand, in FIG. **3(b)**, the contour of the first aperture **16a** is shown with a broken line, whereas the contour of the second aperture **18a** is shown with a solid line.

[0060] When viewed from the normal direction of the substrate **10**, the contour of the first aperture **16a** is rectangular, as shown in FIG. **3(a)**. On the other hand, the contour of the second aperture **18a** is not rectangular, as shown in FIG. **3(b)**.

[0061] The second aperture **18a** includes a first portion **18a1** overlapping the first aperture **16a**, and a plurality of second portions **18a2** extending from the first portion **18a1** and not overlapping the first aperture **16a**. In the present embodiment, the second aperture **18a** includes four second portions **18a2**. Two of the four second portions **18a2** are located on one side (left-hand side) of the first portion

18a1 along the horizontal direction (first direction), whereas the other two are located on the other side (right-hand side). More specifically, the former two second portions **18a2** extend from the upper left and from the lower left of the first portion **18a1**, whereas the latter two second portions **18a2** extend from the upper right and from the lower right of the first portion **18a1**.

[0062] Thus, the contour of the second aperture **18a** is H-shaped. Therefore, it can be said that the second aperture **18a** is formed so that the area of the portions of the second aperture **18a** not overlapping the first aperture **16a** is smaller than that in an imaginary case where the contour of the second aperture **18a** is a rectangle whose width along the horizontal direction (first direction) and width along the vertical direction (second direction) are identical to those of the contour of the second aperture **18a**.

[0063] Because of the aforementioned shapes and positioning of the first aperture **16a** in the first interlayer insulating layer **16** and the second aperture **18a** in the dielectric layer **18**, the active matrix substrate **100A** of the

present embodiment improves the definition up to which manufacture is possible, so that manufacture at a high definition than conventional is possible. Hereinafter, the reasons therefor will be described with reference to Comparative Example.

[0064] FIG. 4 and FIG. 5 show an active matrix substrate **1000** according to Comparative Example 1. FIG. 4 is a plan view schematically showing the active matrix substrate **1000**, and FIG. 5 is a cross-sectional view taken along line **5A-5A'** in FIG. 4.

[0065] In the active matrix substrate **1000** according to Comparative Example 1, the shapes and positioning of the first aperture **16a** in the first interlayer insulating layer **16** and the second aperture **18a** in the dielectric layer **18** are different from the shapes and positioning of the first aperture **16a** and the second aperture **18a** of the active matrix substrate **100A** of the present embodiment.

[0066] In the active matrix substrate **1000**, in order to avoid insufficient connection arising from stepping of the upper layer electrodes **19**, as shown in FIG. 4 and FIG. 5, the

second aperture **18a** in the dielectric layer **18** is formed so that its entirety is located within the first aperture **16a** in the first interlayer insulating layer **16** when viewed from the normal direction of the substrate **10**. In other words, the entire contour of the second aperture **18a** is located inside the contour of the first aperture **16a**. Therefore, not only is the width **W1_v** of the first aperture **16a** along the vertical direction (second direction) greater than the width **W2_v** of the second aperture **18a** along the vertical direction, but also the width **W1_h** of the first aperture **16a** along the horizontal direction (first direction) is greater than the width **W2_h** of the second aperture **18a** along the horizontal direction.

[0067] Therefore, in order to shade the neighborhood of the tapered portion of the first aperture **16a** across an appropriate light-shielding width (i.e., the distance from the contour of the first aperture **16a** to the outer edge of the drain electrode **24**) **SW**, it is necessary to also increase the width **W3_h** of the drain electrode **24** along the horizontal direction. Therefore, in the case where a standard pixel

construction with a 1:3 ratio (H/V ratio) between the pixel pitch along the horizontal direction and the pixel pitch along the vertical direction is adopted, it becomes no longer possible to sufficiently secure intralayer spaces **S** along the horizontal direction as the definition increases. Therefore, the active matrix substrate **1000** according to Comparative Example 1 is limited with respect to definition, such that manufacture at a high definition is difficult. Specifically, manufacture at a pixel density of 370 ppi or above becomes difficult.

[0068] On the other hand, in the active matrix substrate **100A** of the present embodiment, the width **W1_H** of the first aperture **16a** along the horizontal direction (first direction) is smaller than the width **W2_H** of the second aperture **18a** along the horizontal direction. Therefore, while securing the same light-shielding width **SW** as conventionally (i.e., without a decrease in the contrast ratio caused by disorderly alignment), the width **W3_H** of the drain electrode **24** along the horizontal direction can be reduced. This makes it possible to secure sufficient intralayer spaces **S**, such that the

definition up to which manufacture is possible (i.e., an upper limit value below which leak defects within the same layer would not be increased) can be increased. Specifically, manufacture is sufficiently possible even when the pixel density is increased to about 450 ppi.

[0069] Note that, in a cross section where the first aperture **16a** has a smaller width than the width of the second aperture **18a** (i.e., a cross section shown in FIG. **2(a)** where $W_{1H} < W_{2H}$), the upper layer electrodes **19** may experience stepping due to the side face shape of the first contact hole **31** becoming steep. However, in the active matrix substrate **100A** of the present embodiment, portions of the contour of the second aperture **18a** are located inside the contour of the first aperture **16a**, whereby stepping of the upper layer electrodes **19** is suppressed in a cross section where the contour of the second aperture **18a** is located inside the contour of the first aperture **16a** (i.e., a cross section shown in FIG. **2(c)**). In FIG. **2(c)**, the left side face shape and the right side face shape of the first contact hole **31** are the same as those of the active matrix substrate **1000**

according to Comparative Example 1. Therefore, beginning from these portions (the portions of the contour of the second aperture **18a** that are located inside the contour of the first aperture **16a**; which herein are part of the upper side and the lower side of the contour of the second aperture **18a**), a sufficient area of contact between each upper layer electrode **19** and each drain electrode **24** can be guaranteed (i.e., equivalent to that of Comparative Example 1 or even higher), thereby realizing an interconnection resistance which is equivalent to or higher than that of Comparative Example 1.

[0070] Thus, the active matrix substrate **100A** of the present embodiment improves the definition up to which manufacture is possible, while securing a performance and an interconnection resistance equivalent to those of the active matrix substrate **1000** according to Comparative Example 1. Moreover, when compared at the same pixel pitch (i.e., the same definition), the intralayer spaces **S** are increased in the active matrix substrate **100A** of the present embodiment, so that leak defects within the same layer can be reduced,

and the production yield can be improved.

[0071] Furthermore, in the active matrix substrate **100A** of the present embodiment, the upper layer electrodes **19** and the lower layer electrode **17** composing storage capacitors are each made of a transparent electrically conductive material, so that sufficient storage capacitances can be secured without allowing the aperture ratio to decrease. Moreover, since the lower layer electrode **17** permits the upper layer electrodes **19** functioning as pixel electrodes to be electrically shielded from the scanning lines **11** and the signal lines **12**, capacitance (parasitic capacitance) is prevented from being generated between the upper layer electrodes **19** and the scanning lines **11** or the signal lines **12**. This decreases the load on the scanning lines **11** and the signal lines **12**, and enables reduced power consumption.

[0072] Note that the aforementioned effect of improving the definition up to which manufacture is possible can also be obtained with the active matrix substrate **1100** of Comparative Example 2 shown in FIG. **6** and FIG. **7**. The active matrix substrate **1100** of Comparative Example 2 differs from

the active matrix substrate **100A** of the present embodiment in that the contour of the second aperture **18a** is rectangular.

[0073] Therefore, when the width **W2_H** of the second aperture **18a** along the horizontal direction and the width **W2_V** along the vertical direction in the active matrix substrate **1100** of Comparative Example 2 are equal to the width **W2_H** of the second aperture **18a** along the horizontal direction and the width **W2_V** along the vertical direction in the active matrix substrate **100A** of the present embodiment, the area of the portions of the second aperture **18a** in the active matrix substrate **100A** of the present embodiment that do not overlap the first aperture **16a** is smaller than the area of the portions of the second aperture **18a** that do not overlap the first aperture **16a** in the active matrix substrate **1100** of Comparative Example 2.

[0074] In the active matrix substrate **1100** of Comparative Example 2, too, the width **W1_H** of the first aperture **16a** along the horizontal direction is smaller than the width **W2_H** of the second aperture **18a** along the horizontal direction. Moreover, when viewed from the normal direction of the

substrate **10**, portions of the contour of the second aperture **18a** are located inside the contour of the first aperture **16a**. Thus, the active matrix substrate **1100** of Comparative Example 2 also improves the definition up to which manufacture is possible, for the same reasons as those described with respect to the active matrix substrate **100A** of the present embodiment.

[0075] However, in the active matrix substrate **1100** of Comparative Example 2, when forming the second aperture **18a** in the dielectric layer **18** (which is made of e.g. SiNx) via dry etching, the surface of the first interlayer insulating layer **16** (which is made of e.g. a photosensitive resin) is also etched, thus disturbing the alignment of liquid crystal molecules in the etched regions. Furthermore, if such regions are not adequately shaded by the drain electrode **24** due to an etching shift of the drain electrode **24** and the dielectric layer **18**, leakage of light will occur.

[0076] FIG. **8** shows regions **R1** in which leakage of light can occur for the aforementioned reason. As shown in FIG. **8**, the portions of the second aperture **18a** that do not overlap

the first aperture **16a** are regions **R1** in which leakage of light may occur. Leakage of light will be a cause for degraded display quality.

[0077] On the other hand, in the active matrix substrate **100A** of the present embodiment, the area of the portions of the second aperture **18a** not overlapping the first aperture **16a** is smaller than that of the active matrix substrate **1100** of Comparative Example 2. This reduces the area of the regions of the surface of the first interlayer insulating layer **16** which are etched when forming the second aperture **18a** in the dielectric layer **18**. As a result, degradation of display quality due to disorderly alignment and leakage of light is suppressed.

[0078] If the second aperture **18a** did not have the second portions **18a2** not overlapping the first aperture **16a** (i.e., if it only had the first portion **18a1**), the area of the regions that end up being etched would be even smaller. However, for reasons mentioned below, it is preferable that the second aperture **18a** includes the second portions **18a2**.

[0079] Consider a case, as shown in FIG. **9(a)**, where the

second aperture **18a** only includes the first portion **18a1**, without including the second portions **18a2**. As shown in FIG. **9(b)**, the second aperture **18a** and the drain electrode **24** as such may deviate from their intended relative positioning due to misalignment. In the example shown in FIG. **9(b)**, the second aperture **18a** is deviated toward the right from the intended position. In a region **R2** in which the second aperture **18a** no longer overlaps the first aperture **16a** due to such deviation, as shown in FIG. **9(c)**, the upper electrode **19** is not in contact with the drain electrode **24**, resulting in a significantly reduced area of contact.

[0080] On the other hand, in the active matrix substrate **100A** of the present embodiment, in which the second aperture **18a** includes the second portions **18a2** not overlapping the first aperture **16a**, the presence of the second portions **18a2** reduces the decrease in the area of contact even under misalignment, as shown in FIGS. **10(a)** and **(b)**. Moreover, as can be seen from FIGS. **10(a)** and **(b)**, at least one (e.g., two) second portion **18a2** among the plurality of (e.g., four) second portions **18a2** is located on one side of the first

portion **18a1** along the horizontal direction, while at least another (e.g., the other two) second portion **18a2** is located on the other side. Thus, the decrease in the area of contact can be reduced even when the second aperture **18a** deviates toward either side along the horizontal direction.

[0081] Next, with reference to FIG. **11** to FIG. **14**, an exemplary method for producing the active matrix substrate **100A** of the present embodiment will be described. FIG. **11** to FIG. **14** are step-by-step cross-sectional views for describing the method for producing the active matrix substrate **100A**. **(a1)** to **(a3)** of FIG. **11** and **(a1)** and **(a2)** of FIG. **12** to FIG. **14** correspond to a cross section taken along line **2A-2A'** in FIG. **1**. Moreover, **(b1)** to **(b3)** of FIG. **11** and **(b1)** and **(b2)** of FIG. **12** to FIG. **14** correspond to a cross section taken along line **2B-2B'** in FIG. **1**, whereas **(c1)** to **(c3)** of FIG. **11** and **(c1)** and **(c2)** of FIG. **12** to FIG. **14** correspond to a cross section taken along line **2C-2C'** in FIG. **1**.

[0082] First, as shown in FIGS. **11(a1)**, **(b1)**, and **(c1)**, a basecoat layer **13** is formed on a substrate **10**. For example, a glass substrate is used as the substrate **10**, and, as the

basecoat layer **13**, a multilayer film (SiO_2/SiON film) of an SiON film (lower layer) with a thickness of 50 nm to 100 nm and an SiO_2 film (upper layer) with a thickness of 50 nm to 200 nm is formed by CVD technique on the surface of this glass substrate.

[0083] Next, as shown in FIGS. **11(a2)**, **(b2)**, and **(c2)**, a semiconductor layer **21** is formed on the basecoat layer **13**. For example, by a known technique, a polycrystalline silicon (poly-Si) layer is formed in island shapes as the semiconductor layer **21**, with a thickness of 30 nm to 60 nm.

[0084] Then, as shown in FIGS. **11(a3)**, **(b3)**, and **(c3)**, a gate insulating layer **14** covering the semiconductor layer **21** is formed. For example, by CVD technique, an SiO_2 film with a thickness of 50 nm to 100 nm is formed as the gate insulating layer **14**. Thereafter, although not shown herein, scanning lines **11** and gate electrodes **22** are formed on the gate insulating layer **14**. For example, by sputtering technique, a multilayer film of a TaN film (lower layer) with a thickness of 30 nm to 50 nm and a W film (upper layer) with a thickness of 300 nm to 400 nm is deposited, and this

multilayer film (W/TaN film) is patterned by photolithography technique to form the scanning lines **11** and the gate electrodes **22**.

[0085] Next, as shown in FIGS. **12(a1)**, **(b1)**, and **(c1)**, a second interlayer insulating layer **15** covering the scanning lines **11** and the gate electrodes **22** is formed. For example, by CVD technique, a multilayer film (SiO₂/SiNx film) of a SiNx film (lower layer) with a thickness of 100 nm to 300 nm and an SiO₂ film (upper layer) with a thickness of 400 nm to 700 nm is formed as the second interlayer insulating layer **15**. Thereafter, via etching, a second contact hole **32** and a third contact hole **33** (not shown herein) through which to expose portions of the semiconductor layer **21** are formed in the gate insulating layer **14** and in the second interlayer insulating layer **15**.

[0086] Then, as shown in FIGS. **12(a2)**, **(b2)**, and **(c2)**, signal lines **12**, source electrodes **23** (not shown herein) and drain electrodes **24** are formed on the second interlayer insulating layer **15**. For example, by sputtering technique, a multilayer film of a Ti film (lower layer) with a thickness

of 30 nm to 50 nm, an Al layer (intermediate layer) with a thickness of 300 nm to 500 nm, and a Ti film (upper layer) with a thickness of 30 nm to 50 nm is deposited, and this multilayer film (Ti/Al/Ti film) is patterned by photolithography technique to form the signal lines **12**, the source electrodes **23**, and the drain electrodes **24**. In this manner, the TFTs **20** can be formed on the substrate **10**.

[0087] Next, as shown in FIGS. **13(a1)**, **(b1)**, and **(c1)**, a first interlayer insulating layer **16** covering the TFT **20** and having first apertures **16a** is formed. Preferably, the first interlayer insulating layer **16** includes a layer of an organic material such as a resin. For example, the first interlayer insulating layer **16** having the first apertures **16a** may be formed by using a positive-type photosensitive resin film with a thickness of 2 μm to 3 μm as the first interlayer insulating layer **16**.

[0088] Then, as shown in FIGS. **13(a2)**, **(b2)**, and **(c2)**, a lower layer electrode (functioning as a storage capacitor line and a storage capacitor electrode) **17** is formed on the first interlayer insulating layer **16**. For example, by

sputtering technique, an ITO film with a thickness of 50 nm to 200 nm is formed as the lower layer electrode **17**. Note that the electrically conductive film of the lower layer electrode **17** is removed near the regions to later become first contact holes **31** (i.e., near the first apertures **16a**).

[0089] Next, as shown in FIGS. **14(a1)**, **(b1)**, and **(c1)**, a dielectric layer **18** having second apertures **18a** is formed on the lower layer electrode **17**. For example, by CVD technique, an SiNx film with a thickness of 100 nm to 300 nm is deposited, and second apertures **18a** are formed in this SiNx film via etching, thus forming the dielectric layer **18**.

[0090] Thereafter, as shown in FIGS. **14(a2)**, **(b2)**, and **(c2)**, on the dielectric layer **18**, upper layer electrodes (functioning as pixel electrodes) **19** which overlap at least portions of the lower layer electrode **17** via the dielectric layer **18** are formed. For example, an ITO film with a thickness of 50 nm to 200 nm is deposited by sputtering technique, and this ITO film is patterned by photolithography technique to form the upper layer electrodes **19**. Each upper layer electrode **19** is electrically connected to a drain

electrode **24** in a first contact hole **31**, which includes the first aperture **16a** in the first interlayer insulating layer **16** and the second aperture **18a** in the dielectric layer **18**.

[0091] The step of forming the first interlayer insulating layer **16** and the step of forming the dielectric layer **18** are conducted in such a manner that the width $W1_H$ of the first aperture **16a** along the horizontal direction (first direction) is smaller than the width $W2_H$ of the second aperture **18a** along the horizontal direction. Moreover, these two steps are conducted in such a manner that, when viewed from the normal direction of the substrate **10**, portions of the contour of the second aperture **18a** are located inside the contour of the first aperture **16a**.

[0092] Furthermore, these two steps are conducted so that, when viewed from the normal direction of the substrate **10**, the contour of the second aperture **18a** is not a rectangular, such that the area of the portions of the second aperture **18a** not overlapping the first aperture **16a** is smaller than that in an imaginary case where the contour of the second aperture **18a** is a rectangle whose width along the horizontal direction

(first direction) and whose width along the vertical direction (second direction) are identical to those of the contour of the second aperture **18a**.

[0093] In this manner, the active matrix substrate **100A** of the present embodiment can be produced.

[0094] Although the present embodiment illustrates an exemplary case where the width **W1_H** of the first aperture **16a** along the horizontal direction (first direction) is smaller than the width **W2_H** of the second aperture **18a** along the horizontal direction, the present invention is not limited thereto. In the case where the drain electrodes **24** are made of the same electrically conductive film as the signal lines **12**, which is the case with the present embodiment, it is preferable that the width **W1_H** of the first aperture **16a** along the horizontal direction is smaller than the width **W2_H** of the second aperture **18a** along the horizontal direction, in order to ensure sufficient intralayer spaces along the horizontal direction. In the case of ensuring sufficient intralayer spaces along the vertical direction, the width of the first aperture **16a** along the vertical direction (second direction)

is made smaller than the width of the second aperture **18a** along the vertical direction. In other words, a construction in which the first aperture **16a** and the second aperture **18a** shown in FIG. **1** are rotated by 90° may be adopted.

[0095] Moreover, although the present embodiment illustrates a pixel structure for a liquid crystal display device of the VA mode, the present invention can be suitably used as a pixel structure for liquid crystal display devices of other display modes, e.g., a pixel structure for a liquid crystal display device of the FFS mode. A liquid crystal display device of the VA mode includes a vertical-alignment type liquid crystal layer, whereas a liquid crystal display device of the FFS mode includes a horizontal-alignment type liquid crystal layer. Moreover, there are no constraints as to the position of the drain electrode **24** within a pixel. Without being limited to near the center of the pixel as is illustrated in FIG. **1** and the like, any optimum position as adapted to the pixel structure (electrode structure) for each given display mode may be used.

[0096] (Embodiment 2)

FIG. 15 and FIG. 16 show an active matrix substrate **100B** according to the present embodiment. FIG. 15 is a plan view schematically showing the active matrix substrate **100B**. FIGS. 16(a), (b), and (c) are cross-sectional views taken along line **16A-16A'**, line **16B-16B'**, and line **16C-16C'** in FIG. 15, respectively.

[0097] In the active matrix substrate **100B**, similarly to the active matrix substrate **100A** of Embodiment 1, the width $W1_H$ of the first aperture **16a** along the horizontal direction (first direction) is smaller than the width $W2_H$ of the second aperture **18a** along the horizontal direction. Moreover, when viewed from the normal direction of the substrate **10**, portions of the contour of the second aperture **18a** are located inside the contour of the first aperture **16a**. Therefore, while securing a performance and an interconnection resistance equivalent to those of the active matrix substrate **1000** of Comparative Example 1, the definition up to which manufacture is possible is improved.

[0098] In the active matrix substrate **100B**, too, similarly to the active matrix substrate **100A** of Embodiment 1, the

contour of the second aperture **18a** is not rectangular. However, the shape of the second aperture **18a** of the active matrix substrate **100B** is different from the shape of the second aperture **18a** of the active matrix substrate **100A** of Embodiment 1.

[0099] Now, with reference to FIGS. **17(a)** and **(b)**, the shapes and positioning of the first aperture **16a** and the second aperture **18a** will be described in more detail. FIGS. **17(a)** and **(b)** are diagrams showing enlarged the neighborhood of the first aperture **16a** and the second aperture **18a**. In FIG. **17(a)**, the contour of the first aperture **16a** is shown with a solid line, whereas the contour of the second aperture **18a** is shown with a broken line. On the other hand, in FIG. **17(b)**, the contour of the first aperture **16a** is shown with a broken line, whereas the contour of the second aperture **18a** is shown with a solid line.

[0100] When viewed from the normal direction of the substrate **10**, the contour of the first aperture **16a** is rectangular, as shown in FIG. **17(a)**. On the other hand, the contour of the second aperture **18a** is not rectangular, as

shown in FIG. 17(b).

[0101] The second aperture **18a** includes a first portion **18a1** overlapping the first aperture **16a**, and a plurality of second portions **18a2** extending from the first portion **18a1** and not overlapping the first aperture **16a**. Whereas the second aperture **18a** of the active matrix substrate **100A** of Embodiment 1 includes four second portions **18a2**, the second aperture **18a** of the active matrix substrate **100B** of the present embodiment includes two second portions **18a2**.

[0102] One of the two second portions **18a2** is located on one side (left-hand side) of the first portion **18a1** along the horizontal direction (first direction), while the other is located on the other side (right-hand side). More specifically, the former second portion **18a2** extends from the upper left of the first portion **18a1**, whereas the latter second portion **18a2** extends from the lower right of the first portion **18a1**.

[0103] Therefore, it can be said that the second aperture **18a** is formed so that the area of the portions of the second aperture **18a** not overlapping the first aperture **16a** is

smaller than that in an imaginary case where the contour of the second aperture **18a** is a rectangle whose width along the horizontal direction (first direction) and width along the vertical direction (second direction) are identical to those of the contour of the second aperture **18a**. Moreover, in the active matrix substrate **100B** of the present embodiment, the second aperture **18a** includes two second portions **18a2**. Therefore, the region of the surface of the first interlayer insulating layer **16** that ends up being etched when forming the second aperture **18a** in the dielectric layer **18** is further reduced in area, as compared to the active matrix substrate **100** of Embodiment 1 where the second aperture **18a** includes four second portions **18a2**. As a result, degradation of display quality due to disorderly alignment and leakage of light is further suppressed.

[0104] One of the two second portions **18a2** is located on one side of the first portion **18a1** along the horizontal direction, while the other second portion **18a2** is located on the other side. Thus, the decrease in the area of contact can be reduced even when the second aperture **18a** deviates

toward either side along the horizontal direction.

[0105] FIG. 18 shows the second aperture **18a** and the drain electrode **24** being deviated from their intended relative positioning due to misalignment. FIG. 18 also shows a region **R2** in which the second aperture **18a** no longer overlaps the first aperture **16a** due to such deviation (i.e., a region which no longer achieves contact), and a region **R1** in which leakage of light may occur. As can be seen from FIG. 18, when the second aperture **18a** and the drain electrode **24** are deviated from their intended relative positioning due to misalignment, the size of the region **R1** and the size of the region **R2** are in tradeoff relationship.

[0106] This may imply that the shape of the second aperture **18a** of the active matrix substrate **100B** of the present embodiment is more preferable from the standpoint of suppressing leakage of light, and that the shape of the second aperture **18a** of the active matrix substrate **100A** of Embodiment 1 is more preferable from the standpoint of increasing the area of contact.

[0107] (Embodiment 3)

FIG. 19 and FIG. 20 show an active matrix substrate **100C** according to the present embodiment. FIG. 19 is a plan view schematically showing the active matrix substrate **100C**. FIGS. 20(a), (b), and (c) are cross-sectional views taken along line **20A-20A'**, line **20B-20B'**, and line **20C-20C'** in FIG. 19, respectively.

[0108] In the active matrix substrate **100C**, similarly to the active matrix substrate **100A** of Embodiment 1, the width $W1_H$ of the first aperture **16a** along the horizontal direction (first direction) is smaller than the width $W2_H$ of the second aperture **18a** along the horizontal direction. Moreover, when viewed from the normal direction of the substrate **10**, portions of the contour of the second aperture **18a** are located inside the contour of the first aperture **16a**. Therefore, while securing a performance and an interconnection resistance equivalent to those of the active matrix substrate **1000** of Comparative Example 1, the definition up to which manufacture is possible is improved.

[0109] In the active matrix substrate **100C**, too, similarly to the active matrix substrate **100A** of Embodiment 1, the

contour of the second aperture **18a** is not rectangular. However, the shape of the second aperture **18a** of the active matrix substrate **100C** is different from the shape of the second aperture **18a** of the active matrix substrate **100A** of Embodiment 1.

[0110] Now, with reference to FIGS. **21(a)** and **(b)**, the shapes and positioning of the first aperture **16a** and the second aperture **18a** will be described in more detail. FIGS. **21(a)** and **(b)** are diagrams showing enlarged the neighborhood of the first aperture **16a** and the second aperture **18a**. In FIG. **21(a)**, the contour of the first aperture **16a** is shown with a solid line, whereas the contour of the second aperture **18a** is shown with a broken line. On the other hand, in FIG. **21(b)**, the contour of the first aperture **16a** is shown with a broken line, whereas the contour of the second aperture **18a** is shown with a solid line.

[0111] When viewed from the normal direction of the substrate **10**, the contour of the first aperture **16a** is rectangular, as shown in FIG. **21(a)**. On the other hand, the contour of the second aperture **18a** is not rectangular, as

shown in FIG. **21(b)** .

[0112] When viewed from the normal direction of the substrate **10**, portions of the contour of the second aperture **18a** are located inside the contour of the first aperture **16a**. More specifically, the contour of the second aperture **18a** includes two sides (an upper side and a lower side) which are inclined with respect to the horizontal direction, each being located partially inside the contour of the first aperture **16a**.

[0113] Moreover, the second aperture **18a** includes a first portion **18a1** overlapping the first aperture **16a**, and a plurality of second portions **18a2** extending from the first portion **18a1** and not overlapping the first aperture **16a**. In the present embodiment, the second aperture **18a** includes four second portions **18a2**. Two of the four second portions **18a2** are located on one side (left-hand side) of the first portion **18a1** along the horizontal direction (first direction), whereas the other two are located on the other side (right-hand side). More specifically, the former two second portions **18a2** extend from the upper left and from the lower

left of the first portion **18a1**, whereas the latter two second portions **18a2** extend from the upper right and from the lower right of the first portion **18a1**.

[0114] As described above, the contour of the second aperture **18a** includes an upper side and a lower side which are inclined with respect to the horizontal direction. Therefore, the first portion **18a1** is a non-rectangular parallelogram (which herein is a rhombus which is not a rectangle).

[0115] Thus, the contour of the second aperture **18a** is an H-shape which is inclined with respect to the horizontal direction and the vertical direction. Therefore, it can be said that the second aperture **18a** is formed so that the area of the portions of the second aperture **18a** not overlapping the first aperture **16a** is smaller than that in an imaginary case where the contour of the second aperture **18a** is a rectangle whose width along the horizontal direction (first direction) and width along the vertical direction (second direction) are identical to those of the contour of the second aperture **18a**. As a result, degradation of display

quality due to disorderly alignment and leakage of light is suppressed.

[0116] It can be said that the second aperture **18a** according to the present embodiment is formed so that the area of the portions of the second aperture **18a** not overlapping the first aperture **16a** is smaller than that in an imaginary case where the contour of the second aperture **18a** is a (non-rectangular) parallelogram whose width along the horizontal direction (first direction) and whose width along the vertical direction (second direction) are identical to those of the contour of the second aperture **18a** (i.e., an imaginary case where the two second portions **18a1** which are on the same side of the first portion **18a1** are continuous).

[0117] FIG. 22 shows the second aperture **18a** and the drain electrode **24** being deviated from their intended relative positioning due to misalignment. FIG. 22 also shows a region **R2** in which the second aperture **18a** no longer overlaps the first aperture **16a** due to such deviation (i.e., a region which no longer achieves contact), and a region **R1** in which leakage of light may occur. As can be seen from FIG. 22,

when the second aperture **18a** and the drain electrode **24** are deviated from their intended relative positioning due to misalignment, the size of the region **R1** and the size of the region **R2** are in tradeoff relationship.

[0118] (Embodiment 4)

FIG. **23** and FIG. **24** show an active matrix substrate **100D** according to the present embodiment. FIG. **23** is a plan view schematically showing the active matrix substrate **100D**. FIGS. **24(a)** and **(b)** are cross-sectional views taken along line **24A-24A'** and line **24B-24B'** in FIG. **23**, respectively.

[0119] In the active matrix substrate **100D**, similarly to the active matrix substrate **100A** of Embodiment 1, the width $W1_H$ of the first aperture **16a** along the horizontal direction (first direction) is smaller than the width $W2_H$ of the second aperture **18a** along the horizontal direction. Moreover, when viewed from the normal direction of the substrate **10**, portions of the contour of the second aperture **18a** are located inside the contour of the first aperture **16a**. Therefore, while securing a performance and an interconnection resistance equivalent to those of the active

matrix substrate **1000** of Comparative Example 1, the definition up to which manufacture is possible is improved.

[0120] In the active matrix substrate **100D**, too, similarly to the active matrix substrate **100A** of Embodiment 1, the contour of the second aperture **18a** is not rectangular. However, the shape of the second aperture **18a** of the active matrix substrate **100D** is different from the shape of the second aperture **18a** of the active matrix substrate **100A** of Embodiment 1.

[0121] Now, with reference to FIGS. **25(a)** and **(b)**, the shapes and positioning of the first aperture **16a** and the second aperture **18a** will be described in more detail. FIGS. **25(a)** and **(b)** are diagrams showing enlarged the neighborhood of the first aperture **16a** and the second aperture **18a**. In FIG. **25(a)**, the contour of the first aperture **16a** is shown with a solid line, whereas the contour of the second aperture **18a** is shown with a broken line. On the other hand, in FIG. **25(b)**, the contour of the first aperture **16a** is shown with a broken line, whereas the contour of the second aperture **18a** is shown with a solid line.

[0122] When viewed from the normal direction of the substrate **10**, the contour of the first aperture **16a** is rectangular, as shown in FIG. **25(a)**. On the other hand, the contour of the second aperture **18a** is not rectangular, as shown in FIG. **25(b)**.

[0123] When viewed from the normal direction of the substrate **10**, portions of the contour of the second aperture **18a** are located inside the contour of the first aperture **16a**. More specifically, the contour of the second aperture **18a** includes two sides (an upper side and a lower side) which are substantially parallel to the horizontal direction, each being located partially inside the contour of the first aperture **16a**.

[0124] Moreover, the second aperture **18a** includes a first portion **18a1** overlapping the first aperture **16a**, and a plurality of second portions **18a2** extending from the first portion **18a1** and not overlapping the first aperture **16a**. In the present embodiment, the second aperture **18a** includes two second portions **18a2**. One of the two second portions **18a2** is located on one side (left-hand side) of the first portion

18a1 along the horizontal direction (first direction), while the other is located on the other side (right-hand side). More specifically, the former second portion **18a2** is a triangle extending from the left of the first portion **18a1**, whereas the latter second portion **18a2** is a triangle extending from the right of the first portion **18a1**.

[0125] Thus, the contour of the second aperture **18a** is a non-rectangular parallelogram. Therefore, it can be said that the second aperture **18a** is formed so that the area of the portions of the second aperture **18a** not overlapping the first aperture **16a** is smaller than that in an imaginary case where the contour of the second aperture **18a** is a rectangle whose width along the horizontal direction (first direction) and width along the vertical direction (second direction) are identical to those of the contour of the second aperture **18a**. As a result, degradation of display quality due to disorderly alignment and leakage of light is suppressed.

[0126] Moreover, in the active matrix substrate **100D** of the present embodiment, the contour of the second aperture **18a** is a non-rectangular parallelogram, which is a simpler

shape than an H-shape; this provides a design advantage with respect to the photomask (i.e., a photomask for forming the second aperture **18a** in the dielectric layer **18**).

[0127] FIG. **26** shows the second aperture **18a** and the drain electrode **24** being deviated from their intended relative positioning due to misalignment. FIG. **26** also shows a region **R2** in which the second aperture **18a** no longer overlaps the first aperture **16a** due to such deviation (i.e., a region which no longer achieves contact), and a region **R1** in which leakage of light may occur. As can be seen from FIG. **26**, when the second aperture **18a** and the drain electrode **24** are deviated from their intended relative positioning due to misalignment, the size of the region **R1** and the size of the region **R2** are in tradeoff relationship.

[0128] (Embodiment 5)

FIG. **27** and FIG. **28** show an active matrix substrate **100E** according to the present embodiment. FIG. **27** is a plan view schematically showing the active matrix substrate **100E**, whereas FIGS. **28(a)**, **(b)**, and **(c)** are cross-sectional views taken along line **28A-28A'**, line **28B-28B'**, and line **28C-28C'**

in FIG. 27, respectively.

[0129] The active matrix substrate **100E** of the present embodiment differs from the active matrix substrate **100A** of Embodiment 1 in terms of positioning of the second contact holes **32** formed in the gate insulating layer **14** and the second interlayer insulating layer **15**.

[0130] In the active matrix substrate **100A** of Embodiment 1, as shown in FIG. 1 and FIG. 2(c), the second contact hole **32** does not overlap the first contact hole **31** when viewed from the normal direction of the substrate **10**.

[0131] On the other hand, in the active matrix substrate **100E** of the present embodiment, as shown in FIG. 27 and FIG. 28(c), at least a portion of the second contact hole **32** overlaps the first contact hole **31** when viewed from the normal direction of the substrate **10**. Moreover, when viewed from the normal direction of the substrate **10**, the center of the first contact hole **31** and the center of the second contact hole **32** are deviated.

[0132] In the active matrix substrate **100E** of the present embodiment, as described above, at least a portion of the

second contact hole **32** overlaps the first contact hole **31**, so that the size of the drain electrode **24** can be further reduced. Therefore, the aperture ratio can be further improved.

[0133] Note that, when adopting a construction in which at least a portion of the second contact hole **32** overlaps the first contact hole **31** as in the present embodiment, it is preferable that the center of the first contact hole **31** and the center of the second contact hole **32** are deviated, as illustrated in FIG. **27** and FIG. **28(c)**. The reason is that, if the center of the first contact hole **31** coincides with the center of the second contact hole **32**, the film thickness to be etched when forming the second apertures **18a** in the dielectric layer **18** will extremely increase, thus leading to a possibility that the dielectric layer **18** cannot be apertured.

[0134] Although Embodiments 1 to 5 above illustrate TFTs **20** of the top gate type, the present invention is not limited thereto. Bottom-gate type TFTs may be used as the TFTs **20**. In that case, the gate insulating layer **14** is provided so as

to cover the gate electrodes **22**. Moreover, the second interlayer insulating layer **15** is provided so as to cover the semiconductor layer **21**. Furthermore, the second contact holes **32** are not formed in the gate insulating layer **14**, but are only formed in the second interlayer insulating layer **15**.

[0135] (liquid crystal display device construction)

Now, a specific construction for a liquid crystal display device in which the active matrix substrates **100A** to **100E** of Embodiments 1 to 5 may be used will be described.

[0136] A liquid crystal display device **200** shown in FIG. **29** includes an active matrix substrate **100**, a counter substrate **110**, and a liquid crystal layer **120**.

[0137] The active matrix substrate **100** is, for example, one of the active matrix substrates **100A** to **100E** of Embodiments 1 to 5.

[0138] The counter substrate **110** is provided opposite from the active matrix substrate **100**. Typically, color filters (not shown) are provided on the counter substrate **110**. Moreover, in display modes (e.g., the VA mode) where a vertical electric field is applied across the liquid crystal

layer **120**, a counter electrode (common electrode; not shown) opposing the pixel electrodes (the upper layer electrodes **19** shown in FIG. **1** and so on) is provided on the counter substrate **110**. In display modes (e.g., the FFS mode) where a lateral electric field is applied across the liquid crystal layer **120**, a common electrode is provided on the active matrix substrate **100**. For example, the lower layer electrode **17** in a two-layer electrode structure may be allowed to function as a common electrode.

[0139] The liquid crystal layer **120** is provided between the active matrix substrate **100** and the counter substrate **110**. As the liquid crystal layer **120**, a vertical-alignment type liquid crystal layer is used under the VA mode, and a horizontal-alignment type liquid crystal layer is used under the FFS mode.

[0140] On the respective surfaces of the active matrix substrate **100** and the counter substrate **110** facing the liquid crystal layer **120**, alignment films **130a** and **130b** are provided. As the alignment films **130a** and **130b**, vertical alignment films or horizontal alignment films are to be used,

depending on the display mode.

[0141] Typically, a pair of polarizers which oppose each other via the liquid crystal layer **120** are provided. Furthermore, as necessary, a phase plate(s) is provided on the rear face side and/or the viewer side of the liquid crystal layer **120**.

[0142] Hereinafter, an example of a specific pixel structure when adopting the VA mode or the FFS mode for the liquid crystal display device **200** will be described. In the examples described below, the shapes and positioning of the first apertures **16a** and the second apertures **18a** in the active matrix substrate **100** are identical to those in the active matrix substrate **100A** of Embodiment 1.

[0143] FIG. **30** shows an example pixel structure under the VA mode. In the example shown in FIG. **30**, the upper layer electrodes **19** functioning as pixel electrodes are so-called spread electrodes. A plurality of columnar spacers **41** are formed on the active matrix substrate **100**. Each columnar spacer **41** is disposed at an intersection between a scanning line **11** and a signal line **12**. In other words, four columnar

spacers **41** are disposed at the four corners of each pixel in total. In the counter electrode on the counter substrate **110**, an aperture **43** is formed in a region corresponding to the center of each pixel.

[0144] Each columnar spacer **41** provides an alignment regulating force which aligns the liquid crystal molecules perpendicularly to the side face thereof. Moreover, each aperture **43** in the counter electrode exhibits an alignment regulating force which, under an applied voltage, inclines the liquid crystal molecules in a direction that is orthogonal to the edge thereof. Therefore, when a voltage is applied across the liquid crystal layer **120**, a liquid crystal domain that takes an axisymmetric alignment (radially-inclined alignment) is created in each pixel. FIG. **16** shows the alignment directions of liquid crystal molecules under an applied voltage with arrows **D**. In one liquid crystal domain, the liquid crystal molecules are aligned in essentially all azimuth directions, whereby good viewing angle characteristics are obtained.

[0145] FIG. **31** shows another example pixel structure in

the case where the VA mode is adopted. In the example shown in FIG. 31, too, in the counter electrode on the counter substrate 110, an aperture 43 is formed in a region corresponding to the center of each pixel. However, in the example shown in FIG. 31, a plurality of columnar spacers 42 are formed not on the active matrix substrate 100 but on the counter substrate 110. Moreover, each columnar spacer 42 is disposed so as to overlap a signal line 12, and, along the vertical direction, located near the center of each pixel.

[0146] In the example shown in FIG. 31, too, when a voltage is applied across the liquid crystal layer 120, the alignment regulating force of the columnar spacers 42 and the alignment regulating force of the apertures 43 in the counter electrode cause a liquid crystal domain having an axisymmetric alignment to be created in each pixel. The direction of the alignment regulating force exerted on the liquid crystal molecules is different between the columnar spacers 41 formed on the active matrix substrate 100 and the columnar spacers 42 formed on the counter substrate 110; therefore, in order to reflect this difference, different

planar positioning schemes are adopted for the columnar spacers **41** formed on the active matrix substrate **100** and the columnar spacers **42** formed on the counter substrate **110**.

[0147] In the example shown in FIG. **31**, bevels **19c** are formed in the upper left corner and lower left corner of the upper layer electrode **19** functioning as a pixel electrode. This is in order to improve display quality by restricting the positions of centers of alignment that form in between pixels. Under an applied voltage across the liquid crystal layer **120**, centers of alignment are created not only at the center of each aperture **43** in the counter electrode (pixel center), but also between any two pixels adjoining along the up-down direction (the vertical direction on the display surface). The alignment regulating force that creates such a center of alignment between pixels may be weakened under the influence of various conditions such as the cell thickness, how the electrode pattern of pixel electrodes is finished, the pretilt angle (in the case where a PSA technique as disclosed in Japanese Laid-Open Patent Publication No. 2002-357830 is applied), and so on. Therefore, the positions of

the centers of alignment along the right-left direction may fluctuate from pixel to pixel. These fluctuations may cause deteriorations in display quality, such as displaying coarseness and abnormal coloration when the viewing angle is inclined along the right-left direction. By forming the bevels **19c** in the upper layer electrodes **19**, it becomes possible to restrict the positions of the centers of alignment between upper and lower pixels. Specifically, when the bevels **19c** are formed at the left-hand side (the upper left corner and lower left corner) of the upper layer electrodes **19** as described above, the centers of alignment can be stabilized at the side where the interval between pixel electrodes (i.e., between upper layer electrodes **19**) is narrower (i.e., at the right-hand side where the bevels **19c** are not formed).

[0148] Although the example shown in FIG. **31** illustrates that the scanning line **11** is disposed across the neighborhood of the center of the pixel, the position of the scanning line **11** is not limited thereto. However, in the case where columnar spacers **42** are formed on the counter substrate **110**,

in order to prevent leakage of light near the columnar spacers **42**, it is preferable to provide a stripe-shaped black matrix (light shielding layer) that extends along the horizontal direction on the counter substrate **110**, in order to shade a region of 3 μm to 5 μm around each columnar spacer **42**. Therefore, as shown in FIG. **31**, the scanning line **11** may be disposed across the neighborhood of the pixel center so as to overlap the black matrix on the counter substrate **110**, thereby realizing a high aperture ratio.

[0149] FIG. **32** and FIG. **33** show still another example pixel structure under the VA mode. In the examples shown in FIG. **32** and FIG. **33**, a plurality of columnar spacers **41** are formed on the active matrix substrate **100**. Each columnar spacer **41** is disposed at an intersection between a scanning line **11** and a signal line **12**. In other words, four columnar spacers **41** are disposed at the four corners of each pixel in total. In the counter electrode on the counter substrate **110**, an aperture **43** is formed in a region corresponding to the center of each pixel.

[0150] Furthermore, in the example shown in FIG. **32** and

FIG. 33, the upper layer electrodes **19** functioning as pixel electrodes have a plurality of slits **19s**. In the example shown in FIG. 32, the plurality of slits **19s** extend substantially parallel to a direction which is at an angle of 45° with respect to the horizontal direction and the vertical direction. In the example shown in FIG. 33, the plurality of slits **19s** extend substantially parallel to the vertical direction. Under an applied voltage, the slits **19s** exhibit an alignment regulating force which inclines the liquid crystal molecules substantially parallel to the direction in which the slits **19s** extend.

[0151] In the examples shown in FIG. 32 and FIG. 33, when a voltage is applied across the liquid crystal layer **120**, alignment regulation is achieved by the alignment regulating force of the columnar spacers **41**, the alignment regulating force of the apertures **43** in the counter electrode, and the alignment regulating force of the plurality of slits **19s** in the upper layer electrodes (pixel electrodes) **19**. In the examples shown in FIG. 32 and FIG. 33, due to the addition of the alignment regulating force of the plurality of slits **19s**

in the upper layer electrodes **19**, the alignment state can be more stable and the response speed more improved than in the example shown in FIG. **30**. Moreover, in the examples shown in FIG. **32** and FIG. **33**, the effective applied voltage across the liquid crystal layer **120** differs between the regions of the upper layer electrodes **19** where the slits **19s** are formed (i.e., the portion located above the pixel and the portion located below) and the region where the slits **19s** are not formed (i.e., the portion located in the center of the pixel). Therefore, different, plural sets of γ characteristics (gray scale dependences of display luminance) are allowed to be mixedly present in one pixel, and displaying can be performed via their composition, whereby the viewing angle dependence of γ characteristics can be reduced. A viewing angle dependence of γ characteristics is a problematic difference between the γ characteristics when observed from the frontal direction and the γ characteristics when observed from an oblique direction, which is visually perceived as a color change when an intermediate gray scale tone is observed from an oblique

direction (called "whitening" or "color shifting").

[0152] FIG. 34 and FIG. 35 show example pixel structures under the FFS mode. In the examples shown in FIG. 34 and FIG. 35, the upper layer electrodes 19 functioning as pixel electrodes have a plurality of slits 19s. The plurality of slits 19s extend substantially parallel to the vertical direction. Moreover, the lower layer electrode 17 functions as a common electrode.

[0153] In the examples shown in FIG. 34 and FIG. 35, when a potential difference is given between the upper layer electrode 19 and the lower layer electrode 17, a lateral electric field (oblique electric field) is generated, such that the lateral electric field controls the alignment state of liquid crystal molecules. In a display mode where a lateral electric field is applied across the liquid crystal layer 120, the alignment direction of the liquid crystal molecules varies within the display surface (i.e., the layer plane of the liquid crystal layer 120), whereby good viewing angle characteristics are obtained.

[0154] In the example shown in FIG. 34, a plurality of

columnar spacers **41** are formed on the active matrix substrate **100**. In the example shown in FIG. **35**, a plurality of columnar spacers **42** are formed on the counter substrate **110**.

INDUSTRIAL APPLICABILITY

[0155] According to an embodiment of the present invention, there is provided an active matrix substrate which can be produced with a higher definition than conventionally, in spite of having a two-layer electrode structure.

REFERENCE SIGNS LIST

[0156] **10** substrate

11 scanning line

12 signal line

13 base coat layer

14 gate insulating layer

15 second interlayer insulating layer

16 first interlayer insulating layer

16a first aperture (aperture in first interlayer
insulating layer)

17 lower electrode

18 dielectric layer

18a second aperture (aperture in dielectric layer)

18a1 first portion of second aperture

18a2 second portion of second aperture

19 upper electrode (pixel electrode)

19s slits

20 thin film transistor (TFT)

21 semiconductor layer

22 gate electrode

23 source electrode

24 drain electrode

31 first contact hole

32 second contact hole

33 third contact hole

41, 42 columnar spacer

43 aperture in counter electrode

100, 100A, 100B active matrix substrate

100C, 100D, 100E active matrix substrate

CLAIMS

1. An active matrix substrate comprising:

a substrate;

a thin film transistor being supported by the substrate and including a semiconductor layer, a gate electrode, a source electrode, and a drain electrode;

a scanning line provided so as to extend substantially parallel to a first direction, and electrically connected to the gate electrode of the thin film transistor;

a signal line provided so as to extend substantially parallel to a second direction orthogonal to the first direction, and electrically connected to the source electrode of the thin film transistor;

a first interlayer insulating layer provided so as to cover the thin film transistor;

a lower layer electrode provided on the first interlayer insulating layer;

a dielectric layer provided on the lower layer electrode; and

an upper layer electrode being provided on the dielectric layer and overlapping at least a portion of the lower layer electrode via the dielectric layer, wherein,

a first contact hole through which a portion of the drain electrode is exposed is formed in the first interlayer insulating layer and the dielectric layer, the first contact hole allowing the upper layer electrode to be electrically connected to the drain electrode;

the first contact hole includes a first aperture formed in the first interlayer insulating layer and a second aperture formed in the dielectric layer;

a width of the first aperture along one of the first direction and the second direction is smaller than a width of the second aperture along the one direction;

when viewed from a normal direction of the substrate,

a portion of the contour of the second aperture is located inside the contour of the first aperture, and

the contour of the second aperture is not rectangular; and

the area of a portion of the second aperture not overlapping the first aperture is smaller than that in an imaginary case where the contour of the second aperture is a rectangle whose width along the first direction and whose width along the second direction are identical to those of the contour of the second aperture.

2. The active matrix substrate of claim 1, wherein, when viewed from the normal direction of the substrate, the contour of the first aperture is rectangular.

3. The active matrix substrate of claim 1 or 2, wherein, when viewed from the normal direction of the substrate, the second aperture includes a first portion overlapping the first aperture, and a plurality of second portions extending from the first portion and not overlapping the first aperture; and

the plurality of second portions include at least one second portion located on one side of the first portion along the one direction and at least another second portion located

on another side.

4. The active matrix substrate of claim 3, wherein,
the plurality of second portions are four second portions; and

two of the four second portions are located on one side of the first portion along the one direction, and the other two are located on another side.

5. The active matrix substrate of any of claims 1 to 4, wherein, when viewed from the normal direction of the substrate, the contour of the second aperture is H-shaped.

6. The active matrix substrate of claim 3, wherein,
the plurality of second portions are two second portions; and

one of the two second portions is located on one side of the first portion along the one direction, and the other is located on another side.

7. The active matrix substrate of any of claims 1 to 3, and 6, wherein, when viewed from the normal direction of the substrate, the contour of the second aperture is a parallelogram.

8. The active matrix substrate of any of claims 1 to 7, wherein, when viewed from the normal direction of the substrate, the contour of the second aperture includes two sides which are substantially parallel to the one direction, each being located partially inside the contour of the first aperture.

9. The active matrix substrate of any of claims 1 to 7, wherein, when viewed from the normal direction of the substrate, the contour of the second aperture includes two sides which are inclined with respect to the one direction, each being located partially inside the contour of the first aperture.

10. The active matrix substrate of any of claims 1 to 9,

wherein a width of the first aperture along the other of the first direction and the second direction is greater than a width of the second aperture along the other direction.

11. The active matrix substrate of any of claims 1 to 10, further comprising:

a gate insulating layer provided between the semiconductor layer and the gate electrode; and

a second interlayer insulating layer provided so as to cover the gate electrode or the semiconductor layer, wherein,

between the gate insulating layer and the second interlayer insulating layer, at least the second interlayer insulating layer has a second contact hole formed therein through which a portion of the semiconductor layer is exposed, the second contact hole allowing the drain electrode to be electrically connected to the semiconductor layer; and

when viewed from the normal direction of the substrate, at least a portion of the second contact hole overlaps the first contact hole.

12. The active matrix substrate of any of claims 1 to 11, wherein the upper layer electrode and the lower layer electrode are each made of a transparent electrically conductive material.

13. The active matrix substrate of any of claims 1 to 12, wherein a width of the first aperture along the first direction is smaller than a width of the second aperture along the first direction.

14. The active matrix substrate of any of claims 1 to 13, wherein the semiconductor layer of the thin film transistor comprises an oxide semiconductor.

15. The active matrix substrate of claim 14, wherein the oxide semiconductor is an In-Ga-Zn-O-type semiconductor.

16. A liquid crystal display device comprising:

the active matrix substrate of any of claims 1 to 15;

a counter substrate provided opposite from the active

matrix substrate; and

a liquid crystal layer provided between the active matrix substrate and the counter substrate.

17. The liquid crystal display device of claim 16 having a plurality of pixels in a matrix arrangement, wherein

the upper layer electrode functions as a pixel electrode.

18. A method of producing an active matrix substrate including:

a thin film transistor including a semiconductor layer, a gate electrode, a source electrode, and a drain electrode;

a scanning line provided so as to extend substantially parallel to a first direction, and electrically connected to the gate electrode of the thin film transistor; and

a signal line provided so as to extend substantially parallel to a second direction orthogonal to the first direction, and electrically connected to the source electrode of the thin film transistor, the method comprising:

step (A) of forming the thin film transistor on a substrate;

step (B) of forming an interlayer insulating layer covering the thin film transistor, the interlayer insulating layer having a first aperture;

step (C) of forming a lower layer electrode on the interlayer insulating layer;

step (D) of forming on the lower layer electrode a dielectric layer having a second aperture; and

step (E) of forming on the dielectric layer an upper layer electrode overlapping at least a portion of the lower layer electrode via the dielectric layer, the upper layer electrode being electrically connected to the drain electrode in a contact hole, the contact hole including the first aperture and the second aperture, wherein,

step (B) and step (D) are performed so that a width of the first aperture along one of the first direction and the second direction is smaller than a width of the second aperture along the one direction, and that, when viewed from

a normal direction of the substrate, a portion of the contour of the second aperture is located inside the contour of the first aperture; and

step (B) and step (D) are performed further so that, when viewed from the normal direction of the substrate, the contour of the second aperture is not rectangular, and that the area of a portion of the second aperture not overlapping the first aperture is smaller than that in an imaginary case where the contour of the second aperture is a rectangle whose width along the first direction and whose width along the second direction are identical to those of the contour of the second aperture.